

ORGANIZING INFORMATION

THE CONFERENCE IS HELD AT:

SOŠ a SOU INFORMATIKY a SPOJŮ, Čichnova 23,
BRNO – Komín

HOW TO GET THERE: (see incl. plan) by a car

From the Brno Trade Fair Exhibition Centre go in direction
Brno-dam. After approx. 4km you will see the OPEL car shop
centre, on the left side. At the crossroads in front of the OPEL
go to the left, at the next crossroads to the right and on the
right side you will see an educational centre:

SOŠ a SOU INFORMATIKY a SPOJŮ
street Čichnova 23, BRNO-Komín

BINDING APPLICATIONS:

Will be mailed together with obligatory demand for
accommodation with meals before **October 15, 2010**
to the address:

SMT-INFO consortium
Údolní 53, 602 00 BRNO
CZECH REPUBLIC

e-mail: smtinfo@nexta.cz
fax: 00420-546 211 009

ACCOMMODATION WITH MEALS:

Participants will be accommodated in the
BOBY CENTRUM Brno ***

REGISTRATION:

In the conference hall
October 19, 2010 8.00 - 8.45 a.m.

PROFESSIONAL GUARANTOR:

SMT-INFO, Údolní 53, 602 00 BRNO
CZECH REPUBLIC

tel.: 00420-541 146 113
mobil: 00420-602 542 966
fax: 00420-546 211 009
e-mail: smtinfo@nexta.cz

Internet: www.smtinfo.cz

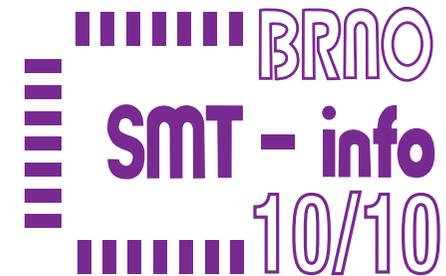
SMT-INFO CONSORTIUM

in cooperation with

FEKT VUT Brno
and

SOŠ a SOU INFORMATIKY A SPOJŮ

have the pleasure to invite you
to participate in the international conference



SOLDERING AND REPAIRS PCB's IN ELECTRONICS

NEW TRENDS IN MICROELECTRONICS

October 19, 2010
SOŠ a SOU informatiky a spojů
Čichnova 23, Brno-Komín

event. code 10/10

SMT-INFO Consortium
Údolní 53
602 00 BRNO
Czech Republic

CONFERENCE ORIENTATION:

- SOLDERING IN ELECTRONICS
- NEW TRENDS IN MICROELECTRONICS
- TECHNIQUES IN REPAIRING

PROFESSIONAL OFFER

- Seminar participants will be acquainted with the latest information on above mentioned topics presented by specialist from prestigious companies.
- In a room adjacent the lecture theatre, the following company stands will be installed and professional literature and demonstration equipment will be offered there:

AMTECH

AMTEST

PAN ELECTRONICS

RETRONIX

LUKON THERMAL ELECTRONICS

- Advertisement tables will be available for the seminar participants and visitors, providing propagation of their own products and offer of non-used/used technological equipment and services.

THEMATIC ORIENTATION OF OTHER EVENTS

ORGANIZED BY SMT-INFO:

SMT-INFO 02/2011 Brno, February 15, 2011

- PCB DESIGN SYSTEMS
- COMPLEX PRODUCTION LINES FOR MODERN ASSEMBLY
- INSPECTION SYSTEMS

PROFESSIONAL GUARANTOR:

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mobil: 00420-602 542 966, fax: 00420-546 211 009

e-mail: smtinfo@nexta.cz

CONFERENCE SCHEDULE

Tuesday, October 19, 2010

- 8.50 - Conference Opening
- 9.00 - Selective Solder Wave from INTER SELECT
/J. Popelínský, THONAUER Brno/
- 9.20 - Methods of Counterfeit Components Detection
-Preventive Arrangement before Purchase
/J. Kazda, RETRONIX Liberec//
- 9.40 - Emil Otto fluxes for Selective and Wave Soldering
SEHO Selective Line – Latest in Selective Soldering
/H.G.Schroeder, EMIL OTTO Eltville, K. Malysz,
MP ELEKTRONIK TECHNOLOGIE Blansko/
- 10.20 - Coffee, Refreshment
- 10.40 - Solder Paste CVP-520 with Bismuth
/C. Hoppenbrouwers, COOKSON ELECTRONICS,
M. Cichra, ERMEG Liberec/
- 11.20 - Multifunctional Convection Soldering Systems
/M. Hurban, REHM ČR Příbor,
H. Bell, REHM THERMAL SYSTEMS Blaubeuren/
- 11.40 - Stencils Design
/C. Hoppenbrouwers, COOKSON ELECTRONICS,
M. Cichra, ERMEG Liberec/
- 12.20 - Discussion
- 12.30 - Thermal Processes Apart from Soldering
(drying, curing, hardening tec.)
/P. Heilmann, LUKON THERMAL SOLUTIONS
Tauffelen/
- 12.50 - Flexible Access to PCB´s Repair
/M. Duda, PBT Rožnov pod Radhoštěm/
- 13.30 - Lunch
- 14.10 - PDR – SMT/BGA - IR Repair Station
/J. Vondráček, AMTEST CZECH Brno/
- 14.30 - Cleaning – New Trends in Electronics
/Z. Zukał, D. Joura, DCT CZECH Černá Hora/
- 14.50 - How Clean is Clean?
/V. Sitko, PBT Rožnov pod Radhoštěm/
- 15.10 - Antistatic – Standard Test Methods for Specific
Applications (ANSI – ESDA – IEC)
/K. Jurák, Praha/
- 15.30 - Conference Closing, Discussion

**Lectures in English and German will be interpreted.
Program changes reserved.**

Obligatory application for international seminar

**SOLDERING AND REPAIRS PCB´s
IN ELECTRONICS**

NEW TRENDS IN MICROELECTRONICS

October, 19 2010

Name and surname, title

Factory name and address (ZIP code).....

Job function

Telephone Telefax

e-mail

1. Accommodation

from 18th to 19th October, 2010

yes-no

2. Lunch

October 19, 2010

yes-no

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Participant signature

.....
Stamp and signature
of the organization